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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	-
Number of Logic Elements/Cells	15376
Total RAM Bits	423936
Number of I/O	496
Number of Gates	1250000
Voltage - Supply	2.3V ~ 3.6V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	680-LBGA
Supplier Device Package	680-FPSBGA (40x40)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfx1200eb-03fe680c

Product Line	Ordering Part Number	Product Status	Reference PCN
LFX500EC (Cont'd)	LFX500EC-03F900C	**Discontinued**	PCN#09-10
	LFX500EC-03FN900C		
	LFX500EC-04F900C		
	LFX500EC-04FN900C		
	LFX500EC-03F900I		
	LFX500EC-03FN900I		
LFX1200EB	LFX1200EB-03FE680C	**Discontinued**	PCN#03A-10
	LFX1200EB-04FE680C		
	LFX1200EB-05FE680C		
	LFX1200EB-03FE680I		
	LFX1200EB-04FE680I		
	LFX1200EB-03F900C		
	LFX1200EB-04F900C		
	LFX1200EB-05F900C		
	LFX1200EB-03F900I		
	LFX1200EB-04F900I		
LFX1200EC	LFX1200EC-03FE680C	**Discontinued**	PCN#03A-10
	LFX1200EC-04FE680C		
	LFX1200EC-03FE680I		
	LFX1200EC-03F900C		
	LFX1200EC-04F900C		
	LFX1200EC-03F900I		

5555 N.E. Moore Ct. ● Hillsboro, Oregon 97124-6421 ● Phone (503) 268-8000 ● FAX (503) 268-8347
Internet: http://www.latticesemi.com

DC Electrical Characteristics

Over Recommended Operating Conditions

Symbol	Parameter	Condition	Min	Typ	Max	Units
I_{IL}, I_{IH}[1]	Input or I/O Low Leakage	0 ð V_{IN} < (V_{CCO} - 0.2V)	—	—	10	µA
		(V_{CCO} - 0.2V) ð V_{IN} ð 3.6V	—	—	300	µA
I_{IH}[2]	Input High Leakage Current	3.6V < V_{IN} ð 5.5V and 3.0V ð V_{CCO} ð 3.6V	—	—	3	mA
I_{PU}	I/O Active Pull-up Current	0 ð V_{IN} ð 0.7 V_{CCO}	-30	—	-150	µA
I_{PD}	I/O Active Pull-down Current	V_{IL} (MAX) ð V_{IN} ð V_{IH} (MAX)	30	—	150	µA
I_{BHLS}	Bus Hold Low Sustaining Current	V_{IN} = V_{IL} (MAX)	30	—	—	µA
I_{BHHS}	Bus Hold High Sustaining Current	V_{IN} = 0.7 V_{CCO}	-30	—	—	µA
I_{BHLO}	Bus Hold Low Overdrive Current	0 ð V_{IN} ð V_{IH} (MAX)	—	—	150	µA
I_{BHHO}	Bus Hold High Overdrive Current	0 ð V_{IN} ð V_{IH} (MAX)	—	—	-150	µA
V_{BHT}	Bus Hold Trip Points		V_{CCO} * 0.35	—	V_{CCO} * 0.65	V
C_1	I/O Capacitance[3]	V_{CCO} = 3.3V, 2.5V, 1.8V	—	8	—	pf
		V_{CC} = 1.8V, V_{IO} = 0 to V_{IH} (MAX)	—		—	
C_2	Clock Capacitance[3]	V_{CCO} = 3.3V, 2.5V, 1.8V	—	8	—	pf
		V_{CC} = 1.8V, V_{IO} = 0 to V_{IH} (MAX)	—		—	
C_3	Global Input Capacitance[3]	V_{CCO} = 3.3V, 2.5V, 1.8V	—	6	—	pf
		V_{CC} = 1.8V, V_{IO} = 0 to V_{IH} (MAX)	—		—	

1. Input or I/O leakage current is measured with the pin configured as an input or as an I/O with the output driver tri-stated. It is not measured with the output driver active. Bus maintenance circuits are disabled.
2. 5V tolerant inputs and I/Os should be placed in banks where 3.0V ð V_{CCO} ð 3.6V. The JTAG and sysCONFIG ports are not included for the 5V tolerant interface.
3. T_A = 25°C, f = 1.0MHz.

Supply Current

Over Recommended Operating Conditions

Symbol	Parameter	Device	Condition	Min.	Typ.	Max.	Units
I_{CC}[1, 2]	Standby Core Operating Power Supply Current	LFX125	V_{CC} = 3.3V	—	60	—	mA
			V_{CC} = 2.5V	—	60	—	mA
			V_{CC} = 1.8V	—	40	—	mA
		LFX200	V_{CC} = 3.3V	—	70	—	mA
			V_{CC} = 2.5V	—	70	—	mA
			V_{CC} = 1.8V	—	50	—	mA
		LFX500	V_{CC} = 3.3V	—	120	—	mA
			V_{CC} = 2.5V	—	120	—	mA
			V_{CC} = 1.8V	—	100	—	mA
		LFX1200	V_{CC} = 3.3V	—	220	—	mA
			V_{CC} = 2.5V	—	220	—	mA
			V_{CC} = 1.8V	—	200	—	mA
I_{CCO}[3]	Standby Output Power Supply Current		V_{CCO} = 3.3V	—	2.0	—	mA
			V_{CCO} = 2.5V	—	2.0	—	mA
			V_{CCO} = 1.8V	—	2.0	—	mA
			V_{CCO} = 1.5V	—	2.0	—	mA
I_{CCP}[4]	Standby PLL Operating Supply Current		V_{CCP} = 3.3V	—	17.0	—	mA
			V_{CCP} = 2.5V	—	17.0	—	mA
			V_{CCP} = 1.8V	—	15.0	—	mA
I_{CCJ}[5]	Standby IEEE 1149.1 TAP Power Supply Current		V_{CCJ} = 3.3V	—	2.0	—	mA
			V_{CCJ} = 2.5V	—	1.5	—	mA
			V_{CCJ} = 1.8V	—	1.0	—	mA

1. T_A = 25°C, frequency = 1.0 MHz, device configured with 16-bit counters.
2. I_{CC} varies with specific device configuration and operating frequency. For more accurate power calculation, see TN1043, Power Estimation in ispXPGA Devices.
3. T_A = 25°C, per bank, no DC load, frequency = 0 MHz.
4. T_A = 25°C, per PLL, frequency = 10 MHz.
5. T_A = 25°C

sysIO Differential Standards DC Electrical Characteristics[1]

Parameter	Description	Test Conditions	Min.	Typ.	Max.
LVDS[2]					
V_{INP}, V_{INM}	Input voltage		0V	—	2.4V
V_{THD}	Differential input threshold	0.2V ð V_{CM} ð 1.8V	+/-100mV	—	—
I_{IN}	Input current	Power on	—	—	+/-10uA
V_{OH}	Output High Voltage for V_{OP} or V_{OM}	RT = 100 Ohm	—	1.38V	1.60V
V_{OL}	Output Low Voltage for V_{OP} or V_{OM}	RT = 100 Ohm	0.9V	1.03V	—
V_{OD}	Output Voltage Differential	$\|V_{OP} - V_{OM}\|$, R_T = 100 ohm	250mV	350mV	450mV
ΔV_{OD}	Change in V_{OD} between high and low		—	—	50mV
V_{OS}	Output Voltage Offset	$\|V_{OP} + V_{OM}\|/2$, R_T = 100 ohm	1.125V	1.25V	1.375V
ΔV_{OS}	Change in V_{OS} between H and L		—	—	50mV
I_{OSD}	Output short circuit current	V_{OD} = 0V Driver outputs shorted	—	—	24mA
BLVDS[1]					
V_{INP}, V_{INM}	Input voltage		0V	—	2.4V
V_{THD}	Differential input threshold	0.2V ð V_{CM} ð 1.8V	+/-100mV	—	—
I_{IN}	Input current	Power on	—	—	+/-10uA
V_{OH}	Output High Voltage for V_{OP} or V_{OM}	R_T = 27Ω	—	1.4V	1.80V
V_{OL}	Output Low Voltage for V_{OP} or V_{OM}	R_T = 27Ω	0.95V	1.1V	—
V_{OD}	Output Voltage Differential	$\|V_{OP} - V_{OM}\|$, RT = 27Ω	240mV	300mV	460mV
ΔV_{OD}	Change in V_{OD} Between H and L				27mV
V_{OS}	Output Voltage Offset	$\|V_{OP} + V_{OM}\|$ /2, RT = 27Ω	1.1V	1.3V	1.5V
ΔV_{OS}	Change in V_{OS} Between H and L				27mV
I_{OSD}	Output Short Circuit Current	V_{OD} = 0. Driver Outputs Shorted.		36mA	65mA

1. Refer to TN1000, sysIO Usage Guidelines for Lattice Devices.
2. V_{OP} and V_{OM} are the two outputs of the LVDS/BLVDS output buffer.

LVPECL[1]								
DC Parameter	**Parameter Description**	**Min.**	**Max.**	**Min.**	**Max.**	**Min.**	**Max.**	**Units**
V_{CCO}		**3.0**		**3.3**		**3.6**		**V**
V_{IH}	Input Voltage High	1.49	2.72	1.49	2.72	1.49	2.72	V
V_{IL}	Input Voltage Low	0.86	2.125	0.86	2.125	0.86	2.125	V
V_{OH}	Output Voltage High	1.8	2.11	1.92	2.28	2.13	2.41	V
V_{OL}	Output Voltage Low	0.96	1.27	1.06	1.43	1.3	1.57	V
V_{DIFF}[2]	Differential Input threshold	0.3	—	0.3	—	0.3	—	V

1. These values are valid at the output of the source termination pack as shown above with 100-ohm differential load only (see Figure 23). The V_{OH} levels are 200mV below the standard LVPECL levels and are compatible with devices tolerant of the lower common mode ranges.
2. Valid for 0.2 ð V_{CM} ð 1.8V.

ispXPGA 125B/C & ispXPGA 125EB/EC PFU Timing Parameters

Over Recommended Operating Conditions

Parameter	Description	-5[1]		-4		-3		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
Functional Delays								
LUTs								
t_{LUT4}	4-Input LUT Delay	—	0.41	—	0.44	—	0.51	ns
t_{LUT5}	5-Input LUT Delay	—	0.73	—	0.79	—	0.91	ns
t_{LUT6}	6-Input LUT Delay	—	0.86	—	0.93	—	1.07	ns
Shift Register (LUT)								
t_{LSR_S}	Shift Register Setup Time	-0.64	—	-0.62	—	-0.53	—	ns
t_{LSR_H}	Shift Register Hold Time	0.61	—	0.63	—	0.72	—	ns
t_{LSR_CO}	Shift Register Clock to Output Delay	—	0.70	—	0.75	—	0.86	ns
Arithmetic Functions								
$t_{LCTHRUR}$	MC (Macro Cell) Carry In to MC Carry Out Delay (Ripple)	—	0.08	—	0.09	—	0.10	ns
$t_{LCTHRUL}$[2]	MC Carry In to MC Carry Out Delay (Look Ahead)	—	0.05	—	0.05	—	0.06	ns
t_{LSTHRU}	MC Sum In to MC Sum Out Delay	—	0.42	—	0.45	—	0.52	ns
$t_{LSINCOUT}$	MC Sum In to MC Carry Out Delay	—	0.29	—	0.31	—	0.36	ns
$t_{LCINSOUTR}$	MC Carry In to MC Sum Out Delay (Ripple)	—	0.36	—	0.39	—	0.45	ns
$t_{LCINSOUTL}$	MC Carry In to MC Sum Out Delay (Look Ahead)	—	0.26	—	0.28	—	0.32	ns
Feed-thru								
t_{LFT}	PFU Feed-Thru Delay	—	0.15	—	0.16	—	0.18	ns
Distributed RAM								
t_{LRAM_CO}	Clock to RAM Output	—	1.24	—	1.33	—	1.53	ns
t_{LRAMAD_S}	Address Setup Time	-0.41	—	-0.40	—	-0.34	—	ns
t_{LRAMD_S}	Data Setup Time	0.21	—	0.22	—	0.25	—	ns
t_{LRAMWE_S}	Write Enable Setup Time	0.45	—	0.46	—	0.53	—	ns
t_{LRAMAD_H}	Address Hold Time	0.58	—	0.60	—	0.69	—	ns
t_{LRAMD_H}	Data Hold Time	0.11	—	0.11	—	0.13	—	ns
t_{LRAMWE_H}	Write Enable Hold Time	0.12	—	0.12	—	0.14	—	ns
$t_{LRAMCPW}$	Clock Pulse Width (High or Low)	2.91	—	3.00	—	3.45	—	ns
$t_{LRAMADO}$	Address to Output Delay	—	0.86	—	0.93	—	1.07	ns
Register/Latch Delays								
Registers								
t_{L_CO}	Register Clock to Output Delay	—	0.58	—	0.62	—	0.71	ns
t_{L_S}	Register Setup Time (Data before Clock)	0.14	—	0.14	—	0.16	—	ns
t_{L_H}	Register Hold Time (Data after Clock)	-0.12	—	-0.12	—	-0.10	—	ns
t_{LCE_S}	Register Clock Enable Setup Time	-0.11	—	-0.11	—	-0.09	—	ns
t_{LCE_H}	Register Clock Enable Hold Time	0.11	—	0.11	—	0.13	—	ns
Latches								
t_{L_GO}	Latch Gate to Output Delay	—	0.09	—	0.10	—	0.12	ns
t_{LL_S}	Latch Setup Time	0.14	—	0.14	—	0.16	—	ns
t_{LL_H}	Latch Hold Time	-0.12	—	-0.12	—	-0.10	—	ns
t_{LLPD}	Latch Propagation Delay (Transparent Mode)	—	0.09	—	0.10	—	0.12	ns

ispXPGA 125B/C & ispXPGA 125EB/EC PFU Timing Parameters (Cont.)

Over Recommended Operating Conditions

Parameter	Description	-5[1]		-4		-3		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
Reset/Set								
t_{LASSRO}	Asynchronous Set/Reset to Output	—	1.09	—	1.17	—	1.35	ns
$t_{LASSRPW}$	Asynchronous Set/Reset Pulse Width	4.19	—	4.50	—	5.18	—	ns
t_{LASSRR}	Asynchronous Set/Reset Recovery	—	0.51	—	0.55	—	0.63	ns
t_{LSSR_S}	Synchronous Set/Reset Setup Time	-0.03	—	-0.03	—	-0.03	—	ns
t_{LSSR_H}	Synchronous Set/Reset Hold Time	0.03	—	0.03	—	0.03	—	ns

1. Only available for ispXPGA 125B and ispXPGA 125EB (2.5V/3.3V) devices.
2. $t_{LCTHRUL}$ quoted bit by bit.

Timing v.0.3

ispXPGA 125B/C & ispXPGA 125EB/EC PIC Timing Parameters

Parameter	Description	-5[1]		-4		-3		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
Register/Latch Delays								
t_{IO_CO}	Register Clock to Output Delay	—	0.89	—	0.96	—	1.10	ns
t_{IO_S}	Register Setup Time (Data before Clock)	0.05	—	0.05	—	0.06	—	ns
t_{IO_H}	Register Hold Time (Data after Clock)	0.06	—	0.06	—	0.07	—	ns
t_{IOCE_S}	Register Clock Enable Setup Time	-0.03	—	-0.03	—	-0.03	—	ns
t_{IOCE_H}	Register Clock Enable Hold Time	0.13	—	0.13	—	0.15	—	ns
t_{IO_GO}	Latch Gate to Output Delay	—	0.68	—	0.73	—	0.84	ns
t_{IOL_S}	Latch Setup Time	0.05	—	0.05	—	0.06	—	ns
t_{IOL_H}	Latch Hold Time	0.06	—	0.06	—	0.07	—	ns
t_{IOLPD}	Latch Propagation Delay (Transparent Mode)	—	0.09	—	0.10	—	0.12	ns
t_{IOASRO}	Asynchronous Set/Reset to Output	—	1.00	—	1.08	—	1.24	ns
$t_{IOASRPW}$	Asynchronous Set/Reset Pulse Width	4.19	—	4.50	—	5.18	—	ns
t_{IOASRR}	Asynchronous Set/Reset Recovery Time	—	0.23	—	0.25	—	0.29	ns
Input/Output Delays								
t_{IOBUF}	Output Buffer Delay	—	0.97	—	1.04	—	1.20	ns
t_{IOIN}	Input Buffer Delay	—	0.57	—	0.61	—	0.70	ns
t_{IOEN}	Output Enable Delay	—	0.53	—	0.57	—	0.66	ns
t_{IODIS}	Output Disable Delay	—	-0.14	—	-0.13	—	-0.11	ns
t_{IOFT}	Feed-thru Delay	—	0.19	—	0.20	—	0.23	ns

1. Only available for ispXPGA 125B and ispXPGA 125EB (2.5V/3.3V) devices.

Timing v.0.3

ispXPGA 125B/C & ispXPGA 125EB/EC Timing Adders (Cont.)

Parameter	Description	Base Parameter	-5[1]		-4		-3		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
LVCMOS_33_4mA_out	Using 3.3V CMOS Standard, 4mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	1.0	—	1.0	—	1.0	ns
LVCMOS_33_5.33mA_out	Using 3.3V CMOS Standard, 5.33mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	1.0	—	1.0	—	1.0	ns
LVCMOS_33_8mA_out	Using 3.3V CMOS Standard, 8mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.7	—	0.7	—	0.7	ns
LVCMOS_33_12mA_out	Using 3.3V CMOS Standard, 12mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.5	—	0.5	—	0.5	ns
LVCMOS_33_16mA_out	Using 3.3V CMOS Standard, 16mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.5	—	0.5	—	0.5	ns
LVCMOS_33_24mA_out	Using 3.3V CMOS Standard, 24mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.5	—	0.5	—	0.5	ns
AGP_1X_out	Using AGP 1x Standard	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.5	—	0.5	—	0.5	ns
CTT25_out	Using CTT 2.5V	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.5	—	0.5	—	0.5	ns
CTT33_out	Using CTT 3.3V	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.5	—	0.5	—	0.5	ns
GTL+_out	Using GTL+	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.5	—	0.5	—	0.5	ns
HSTL_I_out	Using HSTL 2.5V, Class I	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.5	—	0.5	—	0.5	ns
HSTL_III_out	Using HSTL 2.5V, Class III	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.5	—	0.5	—	0.5	ns
LVDS_out	Using Low Voltage Differential Signaling (LVDS)	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	1.0	—	1.0	—	1.0	ns
BLVDS_out	Using Bus Low Voltage Differential Signaling (BLVDS)	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	1.0	—	1.0	—	1.0	ns
LVPECL_out	Using Low Voltage PECL	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	1.0	—	1.0	—	1.0	ns
PCI_out	Using PCI Standard	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.5	—	0.5	—	0.5	ns
SSTL2_I_out	Using SSTL 2.5V, Class I	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.5	—	0.5	—	0.5	ns
SSTL2_II_out	Using SSTL 2.5V, Class II	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.5	—	0.5	—	0.5	ns
SSTL3_I_out	Using SSTL 3.3V, Class I	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.5	—	0.5	—	0.5	ns
SSTL3_II_out	Using SSTL 3.3V, Class II	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.5	—	0.5	—	0.5	ns

1. Only available for ispXPGA 125B and ispXPGA 125EB (2.5V/3.3V) devices.

Timing v.0.3

ispXPGA 200B/C & ispXPGA 200EB/EC Timing Adders

Parameter	Description	Base Parameter	-5[1]		-4		-3		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
Optional Adders									
$t_{IOINDLY}$	Input Delay	—	—	4.84	—	5.2	—	5.98	ns
t_{IOI} Input Adjusters									
LVTTL_in	Using 3.3V TTL	t_{IOIN}	—	0.5	—	0.5	—	0.5	ns
LVCMOS_18_in	Using 1.8V CMOS	t_{IOIN}	—	0.0	—	0.0	—	0.0	ns
LVCMOS_25_in	Using 2.5V CMOS	t_{IOIN}	—	0.3	—	0.3	—	0.3	ns
LVCMOS_33_in	Using 3.3V CMOS	t_{IOIN}	—	0.5	—	0.5	—	0.5	ns
AGP_1X_in	Using AGP 1x	t_{IOIN}	—	1.0	—	1.0	—	1.0	ns
CTT25_in	Using CTT 2.5V	t_{IOIN}	—	1.0	—	1.0	—	1.0	ns
CTT33_in	Using CTT 3.3V	t_{IOIN}	—	1.0	—	1.0	—	1.0	ns
GTL+_in	Using GTL+	t_{IOIN}	—	0.5	—	0.5	—	0.5	ns
HSTL_I_in	Using HSTL 2.5V, Class I	t_{IOIN}	—	0.5	—	0.5	—	0.5	ns
HSTL_III_in	Using HSTL 2.5V, Class III	t_{IOIN}	—	0.5	—	0.5	—	0.5	ns
LVDS_in	Using Low Voltage Differential Signaling (LVDS)	t_{IOIN}	—	0.8	—	0.8	—	0.8	ns
BLVDS_in	Using Bus Low Voltage Differential Signaling (BLVDS)	t_{IOIN}	—	0.8	—	0.8	—	0.8	ns
LVPECL_in	Using Low Voltage PECL	t_{IOIN}	—	0.8	—	0.8	—	0.8	ns
PCI_in	Using PCI	t_{IOIN}	—	1.0	—	1.0	—	1.0	ns
SSTL2_I_in	Using SSTL 2.5V, Class I	t_{IOIN}	—	0.8	—	0.8	—	0.8	ns
SSTL2_II_in	Using SSTL 2.5V, Class II	t_{IOIN}	—	0.5	—	0.5	—	0.5	ns
SSTL3_I_in	Using SSTL 3.3V, Class I	t_{IOIN}	—	0.8	—	0.8	—	0.8	ns
SSTL3_II_in	Using SSTL 3.3V, Class II	t_{IOIN}	—	0.8	—	0.8	—	0.8	ns
t_{IOO} Output Adjusters									
Slow Slew	Using Slow Slew (LVTTL and LVCMOS Outputs only)	t_{IOBUF}, t_{IOEN}	—	0.7	—	0.7	—	0.7	ns
LVTTL_out	Using 3.3V TTL Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	1.0	—	1.0	—	1.0	ns
LVCMOS_18_4mA_out	Using 1.8V CMOS Standard, 4mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.8	—	0.8	—	0.8	ns
LVCMOS_18_5.33mA_out	Using 1.8V CMOS Standard, 5.33mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.6	—	0.6	—	0.6	ns
LVCMOS_18_8mA_out	Using 1.8V CMOS Standard, 8mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.0	—	0.0	—	0.0	ns
LVCMOS_18_12mA_out	Using 1.8V CMOS Standard, 12mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.2	—	0.2	—	0.2	ns
LVCMOS_25_4mA_out	Using 2.5V CMOS Standard, 4mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.7	—	0.7	—	0.7	ns
LVCMOS_25_5.33mA_out	Using 2.5V CMOS Standard, 5.33 mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.5	—	0.5	—	0.5	ns
LVCMOS_25_8mA_out	Using 2.5V CMOS Standard, 8mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.5	—	0.5	—	0.5	ns
LVCMOS_25_12mA_out	Using 2.5V CMOS Standard, 12mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.5	—	0.5	—	0.5	ns
LVCMOS_25_16mA_out	Using 2.5V CMOS Standard, 16mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.5	—	0.5	—	0.5	ns

ispXPGA 500B/C & ispXPGA 500EB/EC PFU Timing Parameters

Over Recommended Operating Conditions

Parameter	Description	-5[1]		-4		-3		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
Functional Delays								
LUTs								
t_{LUT4}	4-Input LUT Delay	—	0.41	—	0.44	—	0.51	ns
t_{LUT5}	5-Input LUT Delay	—	0.73	—	0.79	—	0.91	ns
t_{LUT6}	6-Input LUT Delay	—	0.86	—	0.93	—	1.07	ns
Shift Register (LUT)								
t_{LSR_S}	Shift Register Setup Time	-0.64	—	-0.62	—	-0.53	—	ns
t_{LSR_H}	Shift Register Hold Time	0.61	—	0.63	—	0.72	—	ns
t_{LSR_CO}	Shift Register Clock to Output Delay	—	0.70	—	0.75	—	0.86	ns
Arithmetic Functions								
$t_{LCTHRUR}$	MC (Macro Cell) Carry In to MC Carry Out Delay (Ripple)	—	0.08	—	0.09	—	0.10	ns
$t_{LCTHRUL}$[2]	MC Carry In to MC Carry Out Delay (Look Ahead)	—	0.05	—	0.05	—	0.06	ns
t_{LSTHRU}	MC Sum In to MC Sum Out Delay	—	0.42	—	0.45	—	0.52	ns
$t_{LSINCOUT}$	MC Sum In to MC Carry Out Delay	—	0.29	—	0.31	—	0.36	ns
$t_{LCINSOUTR}$	MC Carry In to MC Sum Out Delay (Ripple)	—	0.36	—	0.39	—	0.45	ns
$t_{LCINSOUTL}$	MC Carry In to MC Sum Out Delay (Look Ahead)	—	0.26	—	0.28	—	0.32	ns
Feed-thru								
t_{LFT}	PFU Feed-Thru Delay	—	0.15	—	0.16	—	0.18	ns
Distributed RAM								
t_{LRAM_CO}	Clock to RAM Output	—	1.24	—	1.33	—	1.53	ns
t_{LRAMAD_S}	Address Setup Time	-0.41	—	-0.40	—	-0.34	—	ns
t_{LRAMD_S}	Data Setup Time	0.21	—	0.22	—	0.25	—	ns
t_{LRAMWE_S}	Write Enable Setup Time	0.45	—	0.46	—	0.53	—	ns
t_{LRAMAD_H}	Address Hold Time	0.58	—	0.60	—	0.69	—	ns
t_{LRAMD_H}	Data Hold Time	0.11	—	0.11	—	0.13	—	ns
t_{LRAMWE_H}	Write Enable Hold Time	0.12	—	0.12	—	0.14	—	ns
$t_{LRAMCPW}$	Clock Pulse Width (High or Low)	2.91	—	3.00	—	3.45	—	ns
$t_{LRAMADO}$	Address to Output Delay	—	0.86	—	0.93	—	1.07	ns
Register/Latch Delays								
Registers								
t_{L_CO}	Register Clock to Output Delay	—	0.58	—	0.62	—	0.71	ns
t_{L_S}	Register Setup Time (Data before Clock)	0.14	—	0.14	—	0.16	—	ns
t_{L_H}	Register Hold Time (Data after Clock)	-0.12	—	-0.12	—	-0.10	—	ns
t_{LCE_S}	Register Clock Enable Setup Time	-0.11	—	-0.11	—	-0.09	—	ns
t_{LCE_H}	Register Clock Enable Hold Time	0.11	—	0.11	—	0.13	—	ns
Latches								
t_{L_GO}	Latch Gate to Output Delay	—	0.09	—	0.10	—	0.12	ns
t_{LL_S}	Latch Setup Time	0.14	—	0.14	—	0.16	—	ns
t_{LL_H}	Latch Hold Time	-0.12	—	-0.12	—	-0.10	—	ns
t_{LLPD}	Latch Propagation Delay (Transparent Mode)	—	0.09	—	0.10	—	0.12	ns

ispXPGA 500B/C & ispXPGA 500EB/EC EBR Timing Parameters

Parameter	Description	-5[1]		-4		-3		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
Synchronous Write								
t_{EBSWAD_S}	Address Setup Delay	0.59	—	0.61	—	0.70	—	ns
t_{EBSWAD_H}	Address Hold Delay	-0.40	—	-0.39	—	-0.33	—	ns
$t_{EBSWCPW}$	Clock Pulse Width	3.16	—	3.40	—	3.91	—	ns
t_{EBSWWE_S}	Write Enable Setup Time	-0.12	—	-0.12	—	-0.10	—	ns
t_{EBSWWE_H}	Write Enable Hold Time	0.16	—	0.16	—	0.18	—	ns
t_{EBSWD_S}	Data Setup Time	0.27	—	0.28	—	0.32	—	ns
t_{EBSWD_H}	Data Hold Time	-0.27	—	-0.26	—	-0.22	—	ns
Synchronous Read								
t_{EBSR_CO}	Clock to Data Delay	—	2.04	—	2.19	—	2.52	ns
t_{EBSRAD_S}	Address Setup Delay	0.10	—	0.10	—	0.12	—	ns
t_{EBSRAD_H}	Address Hold Delay	-0.07	—	-0.07	—	-0.06	—	ns
$t_{EBSRCPW}$	Clock Pulse Width	3.16	—	3.40	—	3.91	—	ns
t_{EBSRCE_S}	Clock Enable Setup Time	-1.76	—	-1.71	—	-1.45	—	ns
t_{EBSRCE_H}	Clock Enable Hold Time	1.64	—	1.69	—	1.94	—	ns
t_{EBSRWE_S}	Write Enable Setup Time	-0.18	—	-0.17	—	-0.14	—	ns
t_{EBSRWE_H}	Write Enable Hold Time	0.12	—	0.12	—	0.14	—	ns
$t_{EBSRWEEN}$	Write Enable to Data Enable Time	—	1.02	—	1.05	—	1.21	ns
$t_{EBSRWEDIS}$	Write Enable to Data Disable Time	—	0.99	—	1.02	—	1.17	ns
t_{EBSREN}	Output Enable to Data Enable Time	—	1.02	—	1.05	—	1.21	ns
$t_{EBSRDIS}$	Output Enable to Data Disable Time	—	0.83	—	0.86	—	0.99	ns
Asynchronous Read								
$t_{EBARADO}$	Address to New Valid Data Delay	—	2.39	—	2.46	—	2.83	ns
t_{EBARAD_H}	Address to Previous Valid Data Delay	—	2.10	—	2.17	—	2.50	ns
$t_{EBARWEEN}$	Write Enable to Data Enable Time	—	1.01	—	1.04	—	1.20	ns
$t_{EBARWEDIS}$	Write Enable to Data Disable Time	—	0.98	—	1.01	—	1.16	ns
t_{EBAREN}	Output Enable to Data Enable Time	—	1.02	—	1.05	—	1.21	ns
$t_{EBARDIS}$	Output Enable to Data Disable Time	—	0.83	—	0.86	—	0.99	ns

1. Only available for ispXPGA 500B and ispXPGA 500EB (2.5V/3.3V) devices.

Timing v.0.3

ispXPGA 500B/C & ispXPGA 500EB/EC Timing Adders

Parameter	Description	Base Parameter	-5[1]		-4		-3		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
Optional Adders									
$t_{IOINDLY}$	Input Delay	—	—	5.21	—	5.60	—	6.44	ns
t_{IOI} Input Adjusters									
LVTTL_in	Using 3.3V TTL	t_{IOIN}	—	0.5	—	0.5	—	0.5	ns
LVCMOS_18_in	Using 1.8V CMOS	t_{IOIN}	—	0.0	—	0.0	—	0.0	ns
LVCMOS_25_in	Using 2.5V CMOS	t_{IOIN}	—	0.3	—	0.3	—	0.3	ns
LVCMOS_33_in	Using 3.3V CMOS	t_{IOIN}	—	0.5	—	0.5	—	0.5	ns
AGP_1X_in	Using AGP 1x	t_{IOIN}	—	1.0	—	1.0	—	1.0	ns
CTT25_in	Using CTT 2.5V	t_{IOIN}	—	1.0	—	1.0	—	1.0	ns
CTT33_in	Using CTT 3.3V	t_{IOIN}	—	1.0	—	1.0	—	1.0	ns
GTL+_in	Using GTL+	t_{IOIN}	—	0.5	—	0.5	—	0.5	ns
HSTL_I_in	Using HSTL 2.5V, Class I	t_{IOIN}	—	0.5	—	0.5	—	0.5	ns
HSTL_III_in	Using HSTL 2.5V, Class III	t_{IOIN}	—	0.5	—	0.5	—	0.5	ns
LVDS_in	Using Low Voltage Differential Signaling (LVDS)	t_{IOIN}	—	0.8	—	0.8	—	0.8	ns
BLVDS_in	Using Bus Low Voltage Differential Signaling (BLVDS)	t_{IOIN}	—	0.8	—	0.8	—	0.8	ns
LVPECL_in	Using Low Voltage PECL	t_{IOIN}	—	0.8	—	0.8	—	0.8	ns
PCI_in	Using PCI	t_{IOIN}	—	1.0	—	1.0	—	1.0	ns
SSTL2_I_in	Using SSTL 2.5V, Class I	t_{IOIN}	—	0.8	—	0.8	—	0.8	ns
SSTL2_II_in	Using SSTL 2.5V, Class II	t_{IOIN}	—	0.5	—	0.5	—	0.5	ns
SSTL3_I_in	Using SSTL 3.3V, Class I	t_{IOIN}	—	0.8	—	0.8	—	0.8	ns
SSTL3_II_in	Using SSTL 3.3V, Class II	t_{IOIN}	—	0.8	—	0.8	—	0.8	ns
t_{IOO} Output Adjusters									
Slow Slew	Using Slow Slew (LVTTL and LVCMOS Outputs only)	t_{IOBUF}, t_{IOEN}	—	0.7	—	0.7	—	0.7	ns
LVTTL_out	Using 3.3V TTL Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	1.0	—	1.0	—	1.0	ns
LVCMOS_18_4mA_out	Using 1.8V CMOS Standard, 4mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.8	—	0.8	—	0.8	ns
LVCMOS_18_5.33mA_out	Using 1.8V CMOS Standard, 5.33mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.6	—	0.6	—	0.6	ns
LVCMOS_18_8mA_out	Using 1.8V CMOS Standard, 8mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.0	—	0.0	—	0.0	ns
LVCMOS_18_12mA_out	Using 1.8V CMOS Standard, 12mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.2	—	0.2	—	0.2	ns
LVCMOS_25_4mA_out	Using 2.5V CMOS Standard, 4mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.7	—	0.7	—	0.7	ns
LVCMOS_25_5.33mA_out	Using 2.5V CMOS Standard, 5.33 mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.5	—	0.5	—	0.5	ns
LVCMOS_25_8mA_out	Using 2.5V CMOS Standard, 8mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.5	—	0.5	—	0.5	ns
LVCMOS_25_12mA_out	Using 2.5V CMOS Standard, 12mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.5	—	0.5	—	0.5	ns
LVCMOS_25_16mA_out	Using 2.5V CMOS Standard, 16mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.5	—	0.5	—	0.5	ns

ispXPGA Power Supply and NC Connections[1]

Signal	256-Ball fpBGA[3]	516-Ball fpBGA[3]
V_{CC}	C3, C14, D4, D13, E5, E12, F6, F11, L6, L11, M5, M12, N4, N13, P3, P14	A9, A22, D4, D27, J1, J30, L11, L12, L15, L16, L19, L20, M11, M20, R11, R20, T11, T20, W11, W20, Y11, Y12, Y15, Y16, Y19, Y20, AB1, AB30, AG4, AG27, AK9, AK22
V_{CCO0}	F5, G5	F4, J4, M4, N11, P4, P11
V_{CCO1}	K5, L5	U4, U11, V11, W4, AB4, AE4
V_{CCO2}	M6, M7	Y13, Y14, AG6, AG9, AG12, AG14
V_{CCO3}	M10, M11	Y17, Y18, AG17, AG19, AG22, AG25
V_{CCO4}	K12, L12	U20, U27, V20, W27, AB27, AE27
V_{CCO5}	G12, F12	F27, J27, M27, N20, P20, P27
V_{CCO6}	E10, E11	D17, D19, D22, D25, L17, L18
V_{CCO7}	E6, E7	D6, D9, D12, D14, L13, L14
V_{CCP}	H3, J15	R4, T30
V_{CCJ}	A2	C4
GND	A1, A16, B2, B15, F7, F8, F9, F10, G6, G7, G8, G9, G10, G11, H6, H7, H8, H9, H10, H11, J6, J7, J8, J9, J10, J11, K6, K7, K8, K9, K10, K11, L7, L8, L9, L10, R2, R15, T1, T16	A1, A30, B2, B29, C3, C28, M12, M13, M14, M15, M16, M17, M18, M19, N12, N13, N14, N15, N16, N17, N18, N19, P12, P13, P14, P15, P16, P17, P18, P19, R12, R13, R14, R15, R16, R17, R18, R19, T12, T13, T14, T15, T16, T17, T18, T19, U12, U13, U14, U15, U16, U17, U18, U19, V12, V13, V14, V15, V16, V17, V18, V19, W12, W13, W14, W15, W16, W17, W18, W19, AH3, AH28, AJ2, AJ29, AK1, AK30
GND_P	H15, J4	R29, T4
NC[2]	—	**LFX125:** A10, A13, A16, A17, A24, A25, A26, A4, A5, A6, A7, AA1, AA2, AA28, AA29, AA3, AB28, AC1, AC28, AD1, AD27, AD4, AE28, AE29, AE3, AE30, AF27, AF28, AF29, AF3, AF4, AG1, AG10, AG11, AG15, AG2, AG20, AG23, AG24, AG29, AG3, AG8, AH1, AH15, AH19, AH2, AH20, AH23, AH24, AH30, AH7, AH8, AH9, AJ1, AJ12, AJ14, AJ15, AJ19, AJ20, AJ21, AJ23, AJ24, AJ25, AJ27, AJ30, AJ6, AJ7, AJ8, AK11, AK14, AK15, AK20, AK21, AK23, AK24, AK25, AK27, AK5, AK6, AK7, B10, B13, B16, B17, B18, B23, B24, B25, B5, B6, B7, C11, C13, C14, C16, C17, C22, C23, C24, C25, C6, C7, C8, D11, D16, D23, D24, D28, D29, D3, D7, D8, E30, E4, F1, F29, F30, G1, G2, G27, G28, G29, G30, H1, H2, H27, H28, H29, H30, J2, J28, J29, J3, K1, K2, K27, K28, K3, K4, L1, L2, L27, L3, L4, M1, M2, M29, M3, M30, V27, V28, V3, V4, W1, W30, Y1, Y27, Y28, Y3, Y30 **LFX200:** A26, A25, A24, A17, A10, A7, A6, A5, A4, B25, B24, B23, B17, B10, B7, B6, B5, C25, C24, C23, C22, C16, C11, C8, C7, C6, D24, D23, D16, D11, D8, D7, E30, F30, F29, F1, G30, G29, G28, G27, G2, G1, H30, H29, H28, H27, H2, H1, J29, J28, J3, J2, K28, K27, K4, K3, K2, K1, L27, L4, L3, L2, L1, M3, V28, V27, V4, V3, W30, W1, Y30, Y28, Y27, Y3, Y1, AA29, AA28, AA3, AA2, AA1, AD27, AD4, AE28, AE3, AF29, AF28, AF27, AF3, AG29, AG24, AG23, AG20, AG11, AG10, AG8, AG2, AG1, AH30, AH24, AH23, AH20, AH9, AH8, AH7, AH2, AH1, AJ30, AJ27, AJ25, AJ24, AJ23, AJ21, AJ15, AJ12, AJ8, AJ7, AJ6, AJ1, AK27, AK25, AK24, AK23, AK21, AK15, AK11, AK7, AK6, AK5

1. All grounds must be electrically connected at the board level.
2. NC pins should not be connected to any active signals, V_{CC} or GND.
3. Balls for GND, V_{CC} and V_{CCOx} are connected within the substrate to their respective common signals. Pin orientation A1 starts from the upper left corner of the top side view with alphabetical order ascending vertically and numerical order ascending horizontally.

ispXPGA Logic Signal Connections: 256-Ball fpBGA (Cont.)

256-fpBGA Ball	LFX200			LFX125		
	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved[2]	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved[2]
-	GND (Bank 1)	-	-	-	-	-
L3	BK1_IO7	SS_CLKIN0N	16N	BK1_IO7	SS_CLKIN0N	14N
K2	BK1_IO8	-	17P	BK1_IO8	-	15P
-	-	-	-	GND (Bank 1)	-	-
L2	BK1_IO9	-	17N	BK1_IO9	-	15N
M1	BK1_IO10	HSI1A_SOUTP	18P/HSI1	BK1_IO10	-	16P
N1	BK1_IO11	HSI1A_SOUTN	18N/HSI1	BK1_IO11	-	16N
M3	BK1_IO12	PLL_RST2	19P/HSI1	BK1_IO12	PLL_RST2	17P
M4	BK1_IO13	PLL_RST3	19N/HSI1	BK1_IO13	PLL_RST3	17N
-	GND (Bank 1)	-	-	-	-	-
M2	BK1_IO16[1]	VREF1	-	BK1_IO14[1]	VREF1	-
P1	BK1_IO18	HSI1B_SOUTP	22P/HSI1	BK1_IO16	-	19P
-	-	-	-	GND (Bank 1)	-	-
R1	BK1_IO19	HSI1B_SOUTN	22N/HSI1	BK1_IO17	-	19N
N3	BK1_IO20[1]	-	-	BK1_IO18[1]	-	-
N2	BK1_IO22	HSI1B_SINP	24P/HSI1	BK1_IO20	-	21P
-	GND (Bank 1)	-	-	-	-	-
P2	BK1_IO23	HSI1B_SINN	24N/HSI1	BK1_IO21	-	21N
P4	TCK	-	-	TCK	-	-
T2	TMS	-	-	TMS	-	-
T3	TOE	-	-	TOE	-	-
R3	BK2_IO0	-	26P	BK2_IO0	-	22P
R4	BK2_IO1	-	26N	BK2_IO1	-	22N
N5	BK2_IO2	-	27P	BK2_IO2	-	23P
-	GND (Bank 2)	-	-	-	-	-
P5	BK2_IO3	-	27N	BK2_IO3	-	23N
-	-	-	-	GND (Bank 2)	-	-
T4	BK2_IO6	-	29P	BK2_IO6	-	25P
T5	BK2_IO7	-	29N	BK2_IO7	-	25N
N6	BK2_IO8	-	30P	BK2_IO8	-	26P
P6	BK2_IO9	VREF2	30N	BK2_IO9	VREF2	26N
R5	BK2_IO10	-	31P	BK2_IO10	-	27P
-	GND (Bank 2)	-	-	-	-	-
R6	BK2_IO11	-	31N	BK2_IO11	-	27N
N7	BK2_IO12	-	32P	BK2_IO12	-	28P
-	-	-	-	GND (Bank 2)	-	-
P7	BK2_IO13	-	32N	BK2_IO13	-	28N
T6	BK2_IO14	-	33P	BK2_IO14	-	29P
T7	BK2_IO15	-	33N	BK2_IO15	-	29N
M8	BK2_IO16	-	34P	BK2_IO16	-	30P
M9	BK2_IO17	-	34N	BK2_IO17	-	30N
R7	BK2_IO18	-	35P	BK2_IO18	-	31P

ispXPGA Logic Signal Connections: 256-Ball fpBGA (Cont.)

256-fpBGA Ball	LFX200			LFX125		
	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved[2]	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved[2]
C8	BK7_IO1	-	91N	BK7_IO1	-	77N
B8	BK7_IO2	-	92P	BK7_IO2	-	78P
B7	BK7_IO3	-	92N	BK7_IO3	-	78N
A9	BK7_IO6	-	94P	BK7_IO4	-	79P
-	GND (Bank 7)	-	-	-	-	-
A8	BK7_IO7	-	94N	BK7_IO5	-	79N
C7	BK7_IO10	-	96P	BK7_IO6	-	80P
D7	BK7_IO11	-	96N	BK7_IO7	-	80N
D6	BK7_IO12	-	97P	BK7_IO8	-	81P
-	-	-	-	GND (Bank 7)	-	-
C6	BK7_IO13	-	97N	BK7_IO9	-	81N
B6	BK7_IO14	-	98P	BK7_IO10	-	82P
-	GND (Bank 7)	-	-	-	-	-
B5	BK7_IO15	-	98N	BK7_IO11	-	82N
A7	BK7_IO16	VREF7	99P	BK7_IO12	VREF7	83P
A6	BK7_IO17	-	99N	BK7_IO13	-	83N
D5	BK7_IO18	-	100P	BK7_IO14	-	84P
C5	BK7_IO19	-	100N	BK7_IO15	-	84N
A5	BK7_IO20	-	101P	BK7_IO16	-	85P
-	-	-	-	GND (Bank 7)	-	-
A4	BK7_IO21	-	101N	BK7_IO17	-	85N
B4	BK7_IO22	-	102P	BK7_IO18	-	86P
-	GND (Bank 7)	-	-	-	-	-
B3	BK7_IO23	-	102N	BK7_IO19	-	86N
A3	TDO	-	-	TDO	-	-
A2	VCCJ	-	-	VCCJ	-	-
C4	TDI	-	-	TDI	-	-

1. Not available for differential pairs.
2. If a sysHSI Block is used, the indicated sysHSI reserved pins are unavailable for general purpose I/O use.

ispXPGA Logic Signal Connections: 680-Ball fpBGA (Cont.)

LFX1200			
680-Ball fpBGA	Signal Name	Second Function	LVDS Pair/sysHSI Reserved[1]
-	GND (Bank 2)	-	-
K36	BK2_IO19	-	71N
H38	BK2_IO20	-	72P
J38	BK2_IO21	-	72N
J39	BK2_IO22	-	73P
L36	BK2_IO23	-	73N
K38	BK2_IO24	-	74P
M36	BK2_IO25	-	74N
L37	BK2_IO26	-	75P
-	GND (Bank 2)	-	-
K39	BK2_IO27	-	75N
L38	BK2_IO28	-	76P
P35	BK2_IO29	-	76N
N36	BK2_IO30	-	77P
M37	BK2_IO31	-	77N
L39	BK2_IO32	-	78P
M38	BK2_IO33	-	78N
M39	BK2_IO34	-	79P
-	GND (Bank 2)	-	-
P36	BK2_IO35	-	79N
R36	BK2_IO36	-	80P
N37	BK2_IO37	-	80N
P38	BK2_IO38	-	81P
T35	BK2_IO39	-	81N
R37	BK2_IO40	-	82P
R38	BK2_IO41	-	82N
P39	BK2_IO42	-	83P
-	GND (Bank 2)	-	-
R39	BK2_IO43	-	83N
T38	BK2_IO44	-	84P
T36	BK2_IO45	-	84N
T37	BK2_IO46	-	85P
U36	BK2_IO47	-	85N
U37	BK2_IO48	-	86P
T39	BK2_IO49	-	86N
V36	BK2_IO50	-	87P
-	GND (Bank 2)	-	-
U38	BK2_IO51	-	87N
U39	BK2_IO52	-	88P
V38	BK2_IO53	-	88N
V37	BK2_IO54	-	89P
W36	BK2_IO55	-	89N
W35	BK2_IO56	-	90P

ispXPGA Logic Signal Connections: 680-Ball fpBGA (Cont.)

LFX1200			
680-Ball fpBGA	Signal Name	Second Function	LVDS Pair/sysHSI Reserved[1]
AW35	BK4_IO4	-	126P
AV35	BK4_IO5	-	126N
AV34	BK4_IO6	HSI5A_SINP	127P
AU34	BK4_IO7	HSI5A_SINN	127N
AT34	BK4_IO8	-	128P
AU35	BK4_IO9	-	128N
AT33	BK4_IO10	HSI5A_SOUTP	129P/HSI5
-	GND (Bank 4)	-	-
AU33	BK4_IO11	HSI5A_SOUTN	129N/HSI5
AW34	BK4_IO12	VREF4	130P/HSI5
AV33	BK4_IO13	-	130N/HSI5
AR32	BK4_IO14	HSI5B_SINP	131P/HSI5
AT32	BK4_IO15	HSI5B_SINN	131N/HSI5
AU32	BK4_IO16	-	132P/HSI5
AW33	BK4_IO17	-	132N/HSI5
AV32	BK4_IO18	HSI5B_SOUTP	133P/HSI5
-	GND (Bank 4)	-	-
AV31	BK4_IO19	HSI5B_SOUTN	133N/HSI5
AU31	BK4_IO20	-	134P/HSI5
AW32	BK4_IO21	-	134N/HSI5
AR30	BK4_IO22	HSI6A_SINP	135P/HSI5
AT31	BK4_IO23	HSI6A_SINN	135N/HSI5
AW31	BK4_IO24	-	136P/HSI5
AV30	BK4_IO25	-	136N/HSI5
AT30	BK4_IO26	HSI6A_SOUTP	137P/HSI6
-	GND (Bank 4)	-	-
AT29	BK4_IO27	HSI6A_SOUTN	137N/HSI6
AW30	BK4_IO28	-	138P/HSI6
AU29	BK4_IO29	-	138N/HSI6
AT28	BK4_IO30	HSI6B_SINP	139P/HSI6
AU28	BK4_IO31	HSI6B_SINN	139N/HSI6
AV28	BK4_IO32	-	140P/HSI6
AT27	BK4_IO33	-	140N/HSI6
AU27	BK4_IO34	HSI6B_SOUTP	141P/HSI6
-	GND (Bank 4)	-	-
AV27	BK4_IO35	HSI6B_SOUTN	141N/HSI6
AW28	BK4_IO36	-	142P/HSI6
AR26	BK4_IO37	-	142N/HSI6
AW27	BK4_IO38	-	143P/HSI6
AT26	BK4_IO39	-	143N/HSI6
AV26	BK4_IO40	-	144P/HSI6
AR24	BK4_IO41	-	144N/HSI6
AT25	BK4_IO42	-	145P/HSI6

ispXPGA Logic Signal Connections: 900-Ball fpBGA (Cont.)

900 fpBGA Ball	LFX1200			LFX500		
	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved[1]	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved[1]
L2	BK0_IO35	HSI1B_SINN	17N/HSI1	BK0_IO15	HSI0B_SINN	7N/HSI0
L6	BK0_IO36	-	18P/HSI1	BK0_IO16	-	8P/HSI0
L5	BK0_IO37	-	18N/HSI1	BK0_IO17	-	8N/HSI0
M1	BK0_IO38	HSI2A_SOUTP	19P/HSI1	BK0_IO18	HSI1A_SOUTP	9P/HSI1
-	-	-	-	GND (Bank 0)	-	-
M2	BK0_IO39	HSI2A_SOUTN	19N/HSI1	BK0_IO19	HSI1A_SOUTN	9N/HSI1
L3	BK0_IO40	-	20P/HSI1	BK0_IO20	-	10P/HSI1
L4	BK0_IO41	-	20N/HSI1	BK0_IO21	-	10N/HSI1
M6	BK0_IO42	HSI2A_SINP	21P/HSI2	BK0_IO22	HSI1A_SINP	11P/HSI1
-	GND (Bank 0)	-	-	-	-	-
M5	BK0_IO43	HSI2A_SINN	21N/HSI2	BK0_IO23	HSI1A_SINN	11N/HSI1
M4	BK0_IO44	-	22P/HSI2	BK0_IO24	-	12P/HSI1
M3	BK0_IO45	-	22N/HSI2	BK0_IO25	-	12N/HSI1
N1	BK0_IO46	HSI2B_SOUTP	23P/HSI2	BK0_IO26	HSI1B_SOUTP	13P/HSI1
-	-	-	-	GND (Bank 0)	-	-
N2	BK0_IO47	HSI2B_SOUTN	23N/HSI2	BK0_IO27	HSI1B_SOUTN	13N/HSI1
N7	BK0_IO48	-	24P/HSI2	BK0_IO28	-	14P/HSI1
N6	BK0_IO49	-	24N/HSI2	BK0_IO29	-	14N/HSI1
P1	BK0_IO50	HSI2B_SINP	25P/HSI2	BK0_IO30	HSI1B_SINP	15P/HSI1
-	GND (Bank 0)	-	-	-	-	-
P2	BK0_IO51	HSI2B_SINN	25N/HSI2	BK0_IO31	HSI1B_SINN	15N/HSI1
N3	BK0_IO52	-	26P/HSI2	BK0_IO32	-	16P/HSI1
N4	BK0_IO53	-	26N/HSI2	BK0_IO33	-	16N/HSI1
P6	BK0_IO54	PLL_RST0	27P/HSI2	BK0_IO38	PLL_RST0	19P
P5	BK0_IO55	PLL_RST1	27N/HSI2	BK0_IO35	PLL_RST1	17N
P3	BK0_IO56	-	28P/HSI2	BK0_IO36	-	18P
P4	BK0_IO57	-	28N/HSI2	BK0_IO39	-	19N
R7	BK0_IO58	PLL_FBK0	29P	BK0_IO34	PLL_FBK0	17P
-	GND (Bank 0)	-	-	GND (Bank 0)	-	-
R6	BK0_IO59	PLL_FBK1	29N	BK0_IO37	PLL_FBK1	18N
R1	BK0_IO60	CLK_OUT0	30P	BK0_IO40	CLK_OUT0	20P
-	-	-	-	GND (Bank 0)	-	-
R2	BK0_IO61	CLK_OUT1	30N	BK0_IO41	CLK_OUT1	20N
-	GND (Bank 0)	-	-	-	-	-
R3	GCLK0	-	LVDS Pair0P	GCLK0	-	LVDS Pair0P
R4	GCLK1	-	LVDS Pair0N	GCLK1	-	LVDS Pair0N
R5	VCCP0	-	-	VCCP0	-	-
T3	GNDP0	-	-	GNDP0	-	-
T4	GCLK2	-	LVDS Pair1P	GCLK2	-	LVDS Pair1P
T5	GCLK3	-	LVDS Pair1N	GCLK3	-	LVDS Pair1N
-	GND (Bank 1)	-	-	-	-	-
T2	BK1_IO0	CLK_OUT2	31P	BK1_IO0	CLK_OUT2	21P

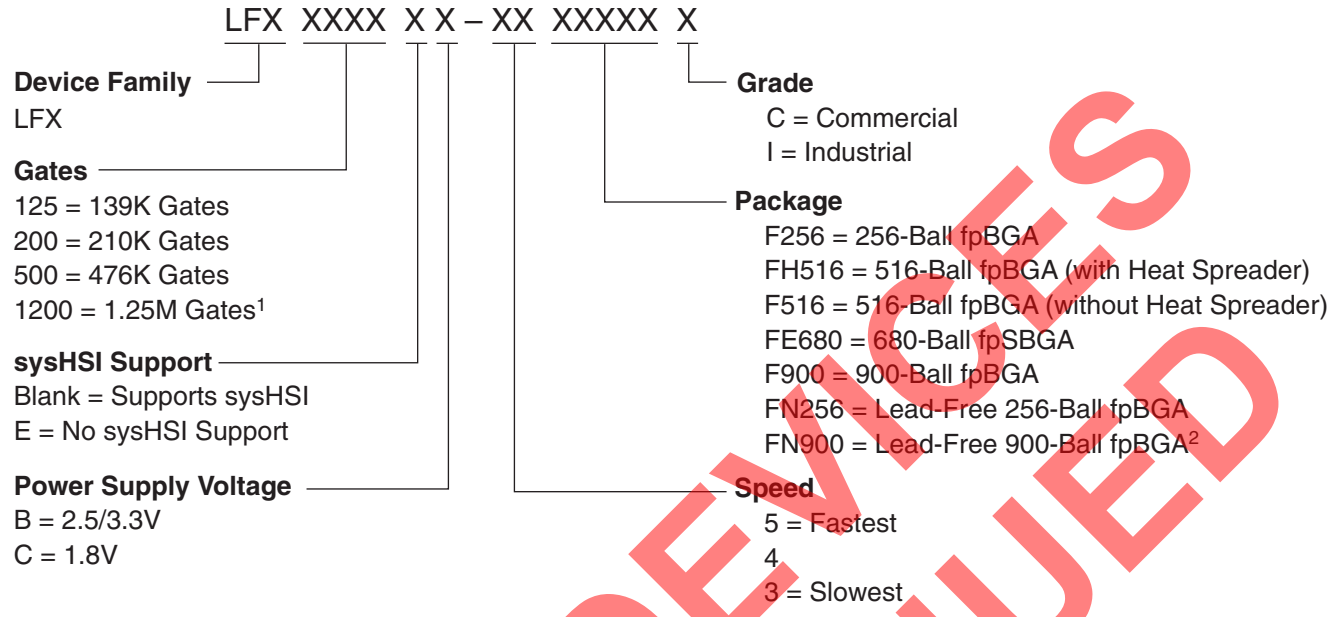
ispXPGA Logic Signal Connections: 900-Ball fpBGA (Cont.)

900 fpBGA Ball	LFX1200			LFX500		
	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved[1]	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved[1]
AK5	BK2_IO7	-	65N	BK2_IO7	-	45N
AE7	BK2_IO8	-	66P	BK2_IO8	-	46P
AF7	BK2_IO9	-	66N	BK2_IO9	-	46N
AG7	BK2_IO10	-	67P	BK2_IO10	-	47P
-	GND (Bank 2)	-	-	GND (Bank 2)	-	-
AH7	BK2_IO11	-	67N	BK2_IO11	-	47N
AE8	BK2_IO12	VREF2	68P	BK2_IO21	VREF2	52N
AF8	BK2_IO13	-	68N	BK2_IO20	-	52P
AJ6	BK2_IO14	-	69P	BK2_IO12	-	48P
AK6	BK2_IO15	-	69N	BK2_IO13	-	48N
AG8	BK2_IO16	-	70P	BK2_IO14	-	49P
AH8	BK2_IO17	-	70N	BK2_IO15	-	49N
AJ7	BK2_IO18	-	71P	BK2_IO16	-	50P
-	GND (Bank 2)	-	-	-	-	-
AK7	BK2_IO19	-	71N	BK2_IO17	-	50N
AF9	BK2_IO20	-	72P	BK2_IO18	-	51P
-	-	-	-	GND (Bank 2)	-	-
AG9	BK2_IO21	-	72N	BK2_IO19	-	51N
AJ8	BK2_IO22	-	73P	NC	-	-
AK8	BK2_IO23	-	73N	NC	-	-
AD10	BK2_IO24	-	74P	NC	-	-
AE10	BK2_IO25	-	74N	NC	-	-
AJ9	BK2_IO26	-	75P	NC	-	-
-	GND (Bank 2)	-	-	-	-	-
AK9	BK2_IO27	-	75N	NC	-	-
AF10	BK2_IO28	-	76P	NC	-	-
AG10	BK2_IO29	-	76N	NC	-	-
AK10	BK2_IO30	-	77P	NC	-	-
AJ10	BK2_IO31	-	77N	NC	-	-
AE11	BK2_IO32	-	78P	NC	-	-
AF11	BK2_IO33	-	78N	NC	-	-
AG11	BK2_IO34	-	79P	NC	-	-
-	GND (Bank 2)	-	-	-	-	-
AH11	BK2_IO35	-	79N	NC	-	-
AE12	BK2_IO36	-	80P	NC	-	-
AF12	BK2_IO37	-	80N	NC	-	-
AJ11	BK2_IO38	-	81P	NC	-	-
AK11	BK2_IO39	-	81N	NC	-	-
AG12	BK2_IO40	-	82P	NC	-	-
AH12	BK2_IO41	-	82N	NC	-	-
AK12	BK2_IO42	-	83P	BK2_IO22	-	53P
-	GND (Bank 2)	-	-	-	-	-

ispXPGA Logic Signal Connections: 900-Ball fpBGA (Cont.)

900 fpBGA Ball	LFX1200			LFX500		
	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved[1]	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved[1]
B15	BK7_IO1	-	217N	BK7_IO1	-	147N
C15	BK7_IO2	-	218P	BK7_IO2	-	148P
-	GND (Bank 7)	-	-		-	-
D15	BK7_IO3	-	218N	BK7_IO3	-	148N
E15	BK7_IO4	-	219P	BK7_IO4	-	149P
F15	BK7_IO5	-	219N	BK7_IO5	-	149N
A14	BK7_IO6	-	220P	BK7_IO6	-	150P
-	-	-	-	GND (Bank 7)	-	-
B14	BK7_IO7	-	220N	BK7_IO7	-	150N
C14	BK7_IO8	-	221P	BK7_IO8	-	151P
D14	BK7_IO9	-	221N	BK7_IO9	-	151N
E14	BK7_IO10	-	222P	BK7_IO10	-	152P
-	GND (Bank 7)	-	-	-	-	-
F14	BK7_IO11	-	222N	BK7_IO11	-	152N
C13	BK7_IO12	-	223P	BK7_IO12	-	153P
D13	BK7_IO13	-	223N	BK7_IO13	-	153N
B13	BK7_IO14	-	224P	BK7_IO14	-	154P
-	-	-	-	GND (Bank 7)	-	-
A13	BK7_IO15	-	224N	BK7_IO15	-	154N
F13	BK7_IO16	-	225P	BK7_IO16	-	155P
G13	BK7_IO17	-	225N	BK7_IO17	-	155N
A12	BK7_IO18	-	226P	BK7_IO18	-	156P
-	GND (Bank 7)	-	-	-	-	-
B12	BK7_IO19	-	226N	BK7_IO19	-	156N
C12	BK7_IO20	-	227P	NC	-	-
D12	BK7_IO21	-	227N	NC	-	-
A11	BK7_IO22	-	228P	NC	-	-
B11	BK7_IO23	-	228N	NC	-	-
E12	BK7_IO24	-	229P	NC	-	-
F12	BK7_IO25	-	229N	NC	-	-
C11	BK7_IO26	-	230P	NC	-	-
-	GND (Bank 7)	-	-	-	-	-
D11	BK7_IO27	-	230N	NC	-	-
E11	BK7_IO28	-	231P	NC	-	-
F11	BK7_IO29	-	231N	NC	-	-
B10	BK7_IO30	-	232P	NC	-	-
A10	BK7_IO31	-	232N	NC	-	-
D10	BK7_IO32	-	233P	NC	-	-
E10	BK7_IO33	-	233N	NC	-	-
A9	BK7_IO34	-	234P	NC	-	-
-	GND (Bank 7)	-	-	-	-	-
B9	BK7_IO35	-	234N	NC	-	-

Part Number Description



1. Discontinued via PCN #03A-10.
2. Select products only. See Ordering Information tables below for specific support.

Ordering Information

Conventional Packaging

Commercial

Part Number	Gates	Voltage	Speed Grade	Package	Balls
LFX125B-05F256C	139K	2.5/3.3	-5	fpBGA	256
LFX125B-04F256C	139K	2.5/3.3	-4	fpBGA	256
LFX125B-03F256C	139K	2.5/3.3	-3	fpBGA	256
LFX125C-04F256C	139K	1.8	-4	fpBGA	256
LFX125C-03F256C	139K	1.8	-3	fpBGA	256
LFX125B-05F516C	139K	2.5/3.3	-5	fpBGA	516
LFX125B-04F516C	139K	2.5/3.3	-4	fpBGA	516
LFX125B-03F516C	139K	2.5/3.3	-3	fpBGA	516
LFX125C-04F516C	139K	1.8	-4	fpBGA	516
LFX125C-03F516C	139K	1.8	-3	fpBGA	516
LFX125B-05FH516C[1]	139K	2.5/3.3	-5	fpBGA	516
LFX125B-04FH516C[1]	139K	2.5/3.3	-4	fpBGA	516
LFX125B-03FH516C[1]	139K	2.5/3.3	-3	fpBGA	516
LFX125C-04FH516C[1]	139K	1.8	-4	fpBGA	516
LFX125C-03FH516C[1]	139K	1.8	-3	fpBGA	516
LFX200B-05F256C	210K	2.5/3.3	-5	fpBGA	256
LFX200B-04F256C	210K	2.5/3.3	-4	fpBGA	256
LFX200B-03F256C	210K	2.5/3.3	-3	fpBGA	256
LFX200C-04F256C	210K	1.8	-4	fpBGA	256
LFX200C-03F256C	210K	1.8	-3	fpBGA	256